

RoHS

COMPLIANT

HALOGEN FREE Available

N-Channel 60-V (D-S) MOSFET

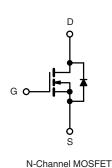
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
60	0.012 at V _{GS} = 10 V	60 ^d	33		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC ٠

APPLICATIONS

- Synchronous Rectifier
- Power Supplies ٠



TO-220AB \bigcirc G D S

Top View

Ordering Information: SUP60N06-12P-E3 (Lead (Pb)-free) SUP60N06-12P-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	60	v	
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	1-	60 ^d		
Continuous Drain Current (1) = 150°C)	T _C = 70 °C	– I _D –	54 ^d	А	
Pulsed Drain Current		I _{DM}	80	A .	
Avalanche Current	I _{AS}	40	1		
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	80	mJ	
Maximum Davies Disain ational	T _C = 25 °C	- P _D -	100 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	'D	3.25	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	1.25	0/11		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	50 μA 250	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	80			Α	
	Р	V _{GS} = 10 V, I _D = 30 A		0.0098	0.012		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.0155	0.019	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		37		S	
Dynamic ^b				- -			
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz		1970		pF	
Output Capacitance	C _{oss}			310			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge ^c	Qg			33	55		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		11		nC	
Gate-Drain Charge ^c	Q _{gd}			9			
Gate Resistance	Rg	f = 1 MHz	0.3	1.4	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 1.53 Ω		11	20		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ 20 A, V_{GEN} = 10 V, R_g = 1 Ω		16	30	ns	
Fall Time ^c	t _f			8	15		
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b					
Continuous Current	ا _S				60	^	
Pulsed Current	I _{SM}				80	A	
Forward Voltage ^a	V _{SD}	$I_{F} = 10 \text{ A}, V_{GS} = 0 \text{ V}$		0.84	1.5	V	
Reverse Recovery Time	t _{rr}			40	80	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 10 A, dl/dt = 100 A/μs		3.2	5.0	Α	
Reverse Recovery Charge	Q _{rr}			64	120	nC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

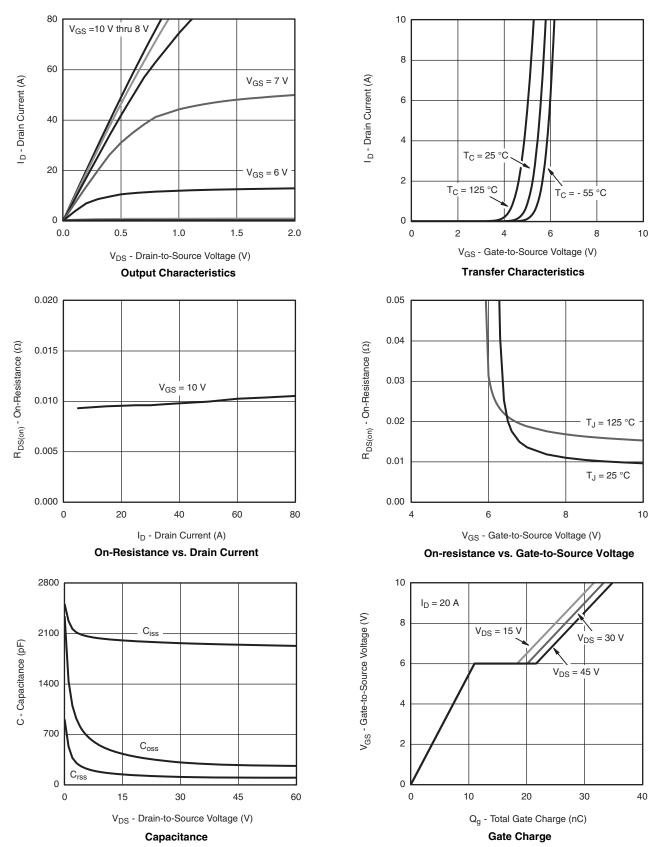
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUP60N06-12P

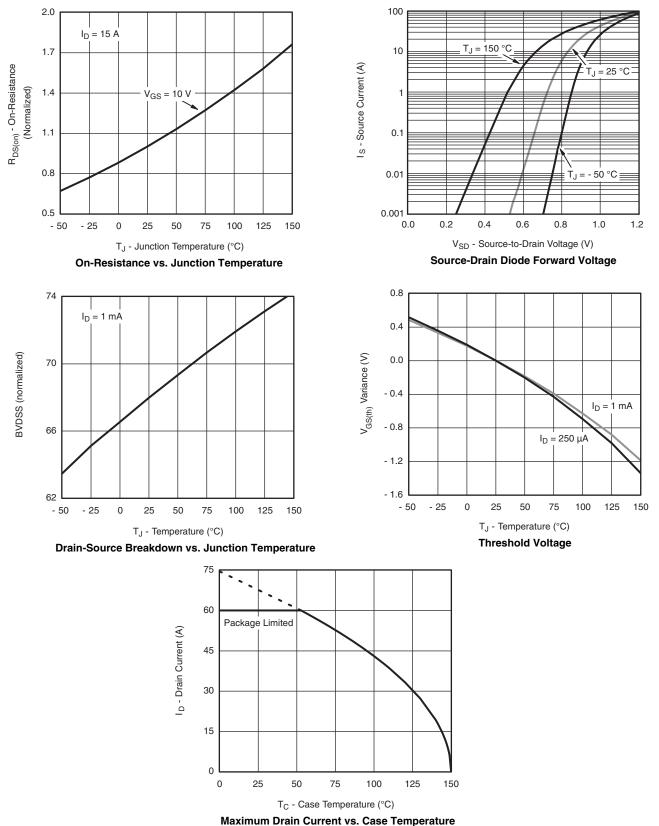
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Document Number: 69070 S10-1475-Rev. C, 05-Jul-10

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



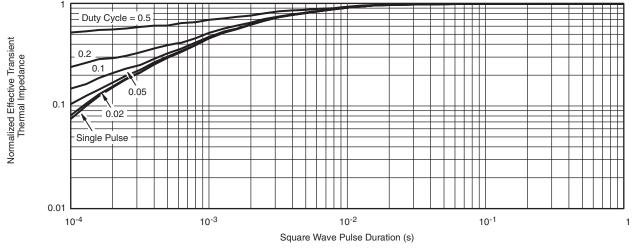
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SUP60N06-12P

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

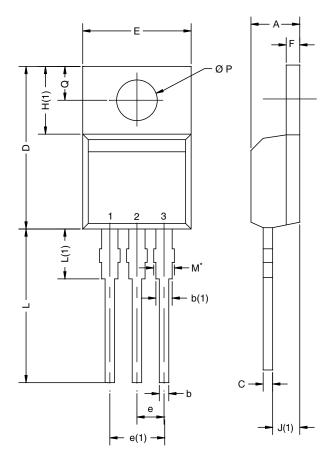


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg269070.



TO-220AB



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T13- DWG: 547	0724-Rev. O, 1	14-Oct-13			

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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